# Product End-of-Life Disassembly Instructions

**Product Category:** Notebooks and Tablet PCs

**Marketing Name / Model**
[List multiple models if applicable.]

HP Pavilion m6 Entertainment PC

**Purpose:** The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

## 1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

<table>
<thead>
<tr>
<th>Item Description</th>
<th>Notes</th>
<th>Quantity of items included in product</th>
</tr>
</thead>
<tbody>
<tr>
<td>Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)</td>
<td>With a surface greater than 10 sq cm Mother board</td>
<td>1</td>
</tr>
<tr>
<td>Batteries</td>
<td>All types including standard alkaline and lithium coin or button style batteries battery and RTC battery</td>
<td>2</td>
</tr>
<tr>
<td>Mercury-containing components</td>
<td>For example, mercury in lamps, display backlights, scanner lamps, switches, batteries</td>
<td></td>
</tr>
<tr>
<td>Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm</td>
<td>Includes background illuminated displays with gas discharge lamps LCD</td>
<td>1</td>
</tr>
<tr>
<td>Cathode Ray Tubes (CRT)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Capacitors / condensers (Containing PCB/PCT)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height</td>
<td></td>
<td></td>
</tr>
<tr>
<td>External electrical cables and cords</td>
<td>Power cords, Adapter</td>
<td>2</td>
</tr>
<tr>
<td>Gas Discharge Lamps</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Plastics containing Brominated Flame Retardants</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner</td>
<td>Include the cartridges, print heads, tubes, vent chambers, and service stations.</td>
<td></td>
</tr>
<tr>
<td>Components and waste containing asbestos</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Components, parts and materials containing refractory ceramic fibers</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Components, parts and materials containing radioactive substances</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
2.0 Tools Required
List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

<table>
<thead>
<tr>
<th>Tool Description</th>
<th>Tool Size (if applicable)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Description #1</td>
<td>screw driver</td>
</tr>
<tr>
<td>Description #2</td>
<td></td>
</tr>
<tr>
<td>Description #3</td>
<td></td>
</tr>
<tr>
<td>Description #4</td>
<td></td>
</tr>
<tr>
<td>Description #5</td>
<td></td>
</tr>
</tbody>
</table>

3.0 Product Disassembly Process
3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. remove Battery Modul
2. remove door
3. remove MINI door
4. remove HDD assy
5. remove RTC battery
6. remove ODD assy
7. remove MINI CARD assy
8. remove KB Module
9. remove log up
10. remove Display assy
11. remove M/B assy
12. remove FAN Module
13. remove USB PCB Module
14. remove ODD PCB Module
15. remove Speaker Module
16. remove Subwoofer Module
17. remove DC_IN_BRK
18. remove K_LOCK_BRK
19. remove DC_IN_Cable
20. remove Power PCB Module
21. remove FP BRK
22. remove FP PCB Module
23. remove TP PCB Module
24. remove LOG UP Plastic (PC+ABS)
25. remove KB SUPPORT BRK
26. remove ODD SUPPORT BRK
27. remove ESD PCB
28. remove Plating BRK
29. remove BAT Latch
30. divide Display assy (remove LCD Bezel)
31. divide Display assy (remove LCD Hinge Brk L-R)
32. divide Display assy (remove LCD Module)
33. divide Display assy (remove LVDS Cable)
34. divide Display assy (remove Antenna MIAN and AUX Cable)
35. divide Display assy (remove Webcam Module)
36. divide Display assy (remove PC+ABS)
37. divide Display assy (remove STAND OFF)
38. divide HDD assy (remove HDD Cable)
39. divide HDD assy (remove HDD Brk assy)
40. divide ODD assy (remove ODD BEZEL assy)
41. divide ODD assy (remove ODD BRK)
3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).
Step 1 Remove Battery ModuL

Step 2 Remove door

Step 3 Remove MINI door

Step 4 Remove HDD assy

Step 5 Remove RTC Batery

Step 6 Remove ODD assy

Step 7 Remove MINI CARD assy
Step 8 Remove KB Module

Step 9 Remove log up

Step 10 Remove Display assy

Step 11 Remove M/B assy

Step 12 Remove FAN Module

Step 13 Remove USB PCB Module
Step 14 Remove ODD PCB Module

Step 15 Remove Speaker Module

Step 16 Remove Subwoofer Module

Step 17 Remove DC_IN_BRK

Step 18 Remove K_LOCK_BRK

Step 19 Remove DC_IN_Cable
Step 20 Remove Power PCB Module

Step 21 Remove FP BRK

Step 22 Remove FP PCB Module

Step 23 Remove TP PCB Module

Step 24 Remove KB SUPPORT BRK

Step 25 Remove ODD SUPPORT BRK
Step 26 Remove LOG UP Plastic (PC+ABS)

Step 27 Remove ESD PCB

Step 28 Remove Plating BRK

Step 29 Remove BAT Latch

Step 30 divide Display assy (remove LCD Bezel)
Step 31 divide Display assy (remove LCD Hinge Brk L-R)

Step 32 divide Display assy (remove LCD Module)

Step 33 divide Display assy (remove LVDS Cable)

Step 34 divide Display assy (remove Antenna MIAN and AUX Cable)

Step 35 divide Display assy (remove Webcam Module)

Step 36 divide Display assy (remove PC+ABS)

Step 37 divide Display assy (remove STANDOFF)
Step 38 divide HDD assy (remove HDD Cable)

Step 39 divide HDD assy (remove HDD Brk assy)

Step 40 divide ODD assy (remove ODD BEZEL assy)

Step 41 divide ODD assy (remove ODD BRK)